IGBT - Field Stop 600 V, 20 A

FGH20N60SFDTU, FGH20N60SFDTU-F085

Description

Using Novel Field Stop IGBT Technology, ON Semiconductor's new series of Field Stop IGBTs offer the optimum performance for Automotive Chargers, Inverter, and other applications where low conduction and switching losses are essential.

Features

- High Current Capability
- Low Saturation Voltage: $V_{CE(sat)} = 2.2 \text{ V} @ I_C = 20 \text{ A}$
- High Input Impedance
- Fast Switching
- Qualified to Automotive Requirements of AEC-Q101 (FGH20N60SFDTU-F085)
- These Devices are Pb-Free and are RoHS Compliant

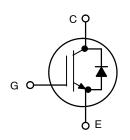
Applications

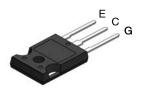
- Automotive Chargers, Converters, High Voltage Auxiliaries
- Inverters, PFC, UPS



ON Semiconductor®

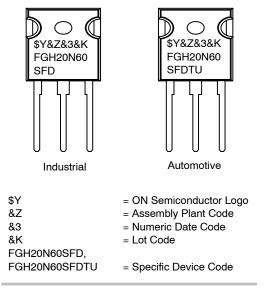
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TO-247-3LD CASE 340CK

MARKING DIAGRAM



ORDERING INFORMATION

See detailed ordering and shipping information on page 2 of this data sheet.

ABSOLUTE MAXIMUM RATINGS

Description	Symbol	Ratings	Unit	
Collector to Emitter Voltage	V _{CES}	600	V	
Gate to Emitter Voltage	V _{GES}	±20	V	
Transient Gate-to-Emitter Voltage		±30	V	
Collector Current Tc = 25°C		Ι _C	40	А
Tc = 100°C			20	А
Pulsed Collector Current	I _{CM} (Note 1)	60	А	
Maximum Power Dissipation Tc = 25°C		PD	165	W
		66	W	
Operating Junction Temperature	TJ	–55 to +150	°C	
Storage Temperature Range	T _{stg}	–55 to +150	°C	
Maximum Lead Temperature for Soldering, 1/8" from Case for 5 Sec	TL	300	°C	

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. Repetitive rating: Pulse width limited by max. junction temperature.

THERMAL CHARACTERISTICS

Parameter	Symbol	Value	Unit
Thermal Resistance Junction-to-Case	$R_{\theta JC}$ (IGBT)	0.76	°C/W
Thermal Resistance Junction-to-Case	$R_{ hetaJC}$ (Diode)	2.51	°C/W
Thermal Resistance Junction-to-Ambient	$R_{ hetaJA}$	40	°C/W

PACKAGE MARKING AND ORDERING INFORMATION

Part Number	Top Mark	Package	Package Method	Reel Size	Tape Width	Quantity
FGH20N60SFDTU	FGH20N60SFD	TO-247	Tube	-	-	30
FGH20N60SFDTU-F085*	FGH20N60SFDTU	TO-247	Tube	-	-	30

*Qualified to Automotive Requirements of AEC-Q101

ELECTRICAL CHARACTERISTICS OF THE IGBT ($T_C = 25^{\circ}C$ unless otherwise noted)

Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit
OFF CHARACTERISTICS	-			-		
Collector to Emitter Breakdown Voltage	BV _{CES}	V_{GE} = 0 V, I_C = 250 μ A	600	-	-	V
Temperature Coefficient of Breakdown Voltage	$\Delta BV_{CES} / \Delta T_{J}$	V_{GE} = 0 V, I _C = 250 µA	-	0.6	_	V/°C
Collector Cut-Off Current	I _{CES}	$V_{CE} = V_{CES}, V_{GE} = 0 V$	-	-	250	μA
G-E Leakage Current	I _{GES}	$V_{GE} = V_{GES}, V_{CE} = 0 V$	-	-	±400	nA
ON CHARACTERISTICs	•	•			•	
G-E Threshold Voltage	V _{GE(th)}	$I_C = 250 \ \mu A, \ V_{CE} = V_{GE}$	4.0	4.6	6.5	V
Collector to Emitter Saturation Voltage	V _{CE(sat)}	I _C = 20 A, V _{GE} = 15 V	-	2.2	2.8	V
		I_{C} = 20 A, V_{GE} = 15 V, T_{C} = 125°C	-	2.4	-	V
DYNAMIC CHARACTERISTICS	-			-		
Input Capacitance	Cies	V_{CE} = 30 V, V_{GE} = 0 V, f = 1 MHz	-	985	-	pF
Output Capacitance	C _{oes}	1	-	110	-	pF
Reverse Transfer Capacitance	C _{res}	1	-	40	-	pF

ELECTRICAL CHARACTERISTICS OF THE IGBT ($T_C = 25^{\circ}C$ unless otherwise noted) (continued)

Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit
SWITCHING CHARACTERISTICS			-			-
Turn-On Delay Time	t _{d(on)}	$V_{CC} = 400 \text{ V}, \text{ I}_{C} = 20 \text{ A},$	-	13	-	ns
Rise Time	t _r	$R_G = 10 \Omega$, $V_{GE} = 15 V$, Inductive Load, $T_C = 25^{\circ}C$	_	18	-	ns
Turn-Off Delay Time	t _{d(off)}	7	_	90	-	ns
Fall Time	t _f	7	-	20	48	ns
Turn-On Switching Loss	E _{on}	7	-	0.43	-	mJ
Turn-Off Switching Loss	E _{off}		-	0.13	-	mJ
Total Switching Loss	E _{ts}		_	0.56	-	mJ
Turn-On Delay Time	t _{d(on)}	$V_{CC} = 400 \text{ V}, \text{ I}_{C} = 20 \text{ A}, \\ R_{G} = 10 \Omega, \text{ V}_{GE} = 15 \text{ V}, \\ \text{Inductive Load, } T_{C} = 125^{\circ}\text{C}$	-	13	-	ns
Rise Time	t _r		_	16	-	ns
Turn-Off Delay Time	t _{d(off)}		_	95	-	ns
Fall Time	t _f	7	_	50	-	ns
Turn-On Switching Loss	E _{on}	7	-	0.53	-	mJ
Turn–Off Switching Loss	E _{off}		-	0.24	-	mJ
Total Switching Loss	E _{ts}		-	0.77	-	mJ
Total Gate Charge	Qg	V_{CE} = 400 V, I _C = 20 A, V _{GE} = 15 V	-	66	-	nC
Gate to Emitter Charge	Q _{ge}	1	-	7	-	nC
Gate to Collector Charge	Q _{gc}	1	_	33	-	nC

ELECTRICAL CHARACTERISTICS OF THE DIODE (T_J = 25° C unless otherwise noted)

Parametr	Symbol	Test Conditions		Min	Тур	Max	Unit
Diode Forward Voltage	V _{FM}	I _F = 10 A	T _C = 25°C	-	1.9	2.5	V
			T _C = 125°C	-	1.7	-	
Diode Reverse Recovery Time	t _{rr}	I_F = 10 A, di _F /dt = 200 A/µs	T _C = 25°C	-	40	-	ns
			T _C = 125°C	-	180	-	
Diode Reverse Recovery Charge	Q _{rr}		$T_{C} = 25^{\circ}C$	-	70	-	nC
			T _C = 125°C	_	495	_	

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

TYPICAL PERFORMANCE CHARACTERISTICS

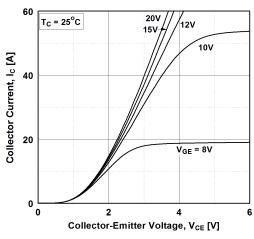


Figure 1. Typical Output Characteristics

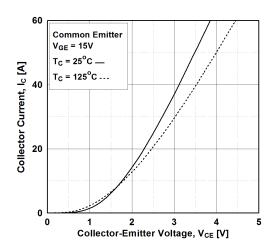


Figure 3. Typical Saturation Voltage Characteristics

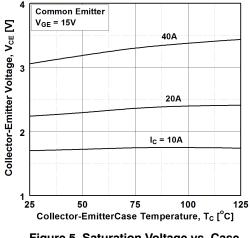


Figure 5. Saturation Voltage vs. Case Temperature at Variant Current Level

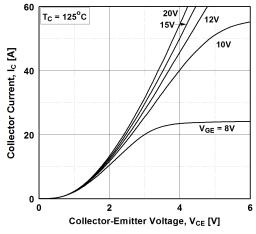
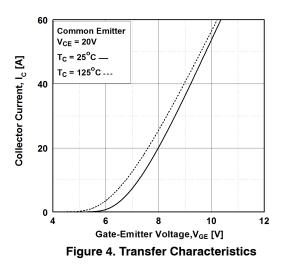


Figure 2. Typical Output Characteristics



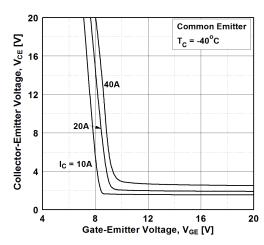


Figure 6. Saturation Voltage vs. V_{GE}

TYPICAL PERFORMANCE CHARACTERISTICS (continued)

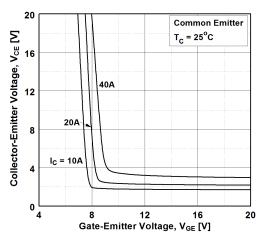


Figure 7. Saturation Voltage vs. V_{GE}

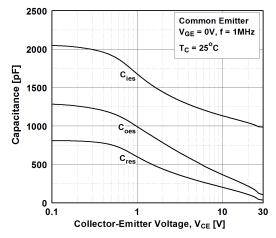
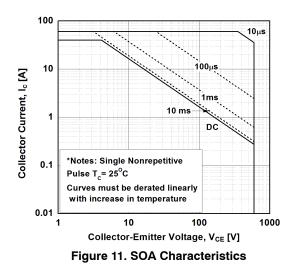


Figure 9. Capacitance Characteristics



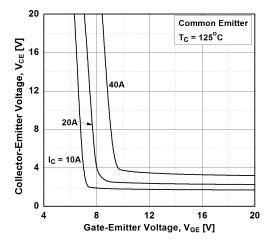


Figure 8. Saturation Voltage vs. V_{GE}

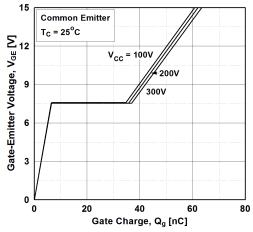
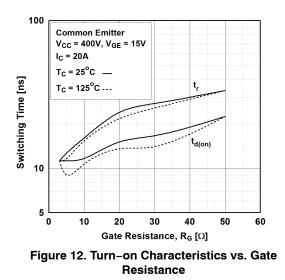
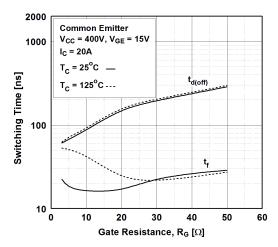


Figure 10. Gate Charge Characteristics



TYPICAL PERFORMANCE CHARACTERISTICS (continued)





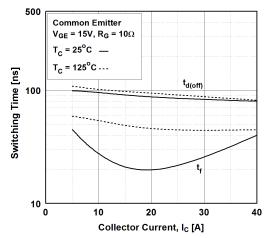
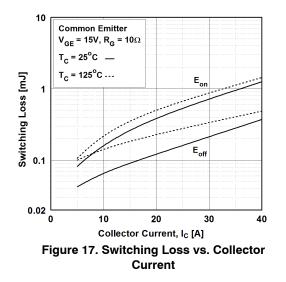


Figure 15. Turn-off Characteristics vs. Collector Current



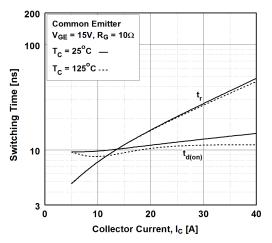


Figure 14. Turn-on Characteristics vs. Collector Current

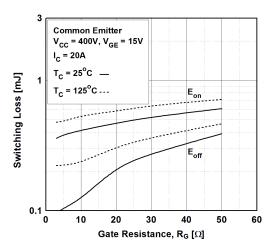
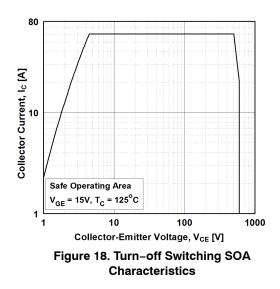


Figure 16. Switching Loss vs. Gate Resistance



TYPICAL PERFORMANCE CHARACTERISTICS (continued)

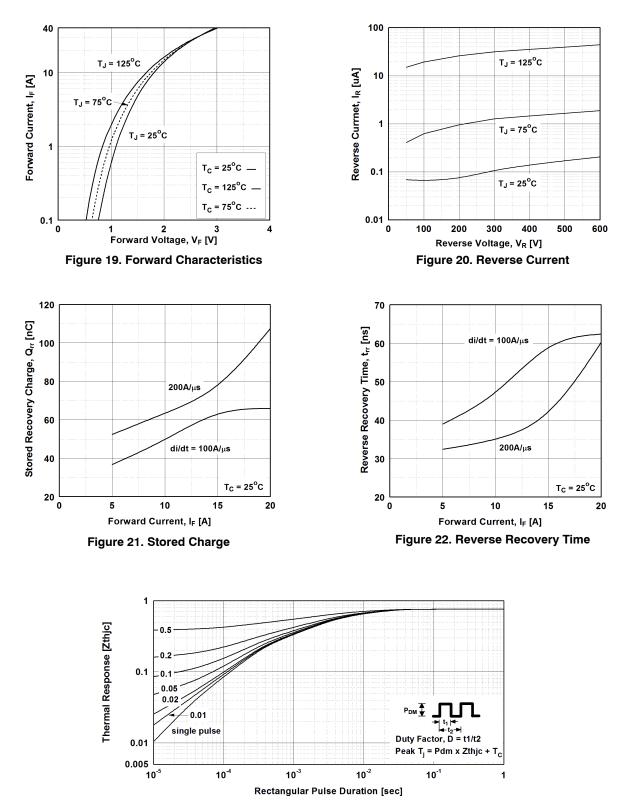
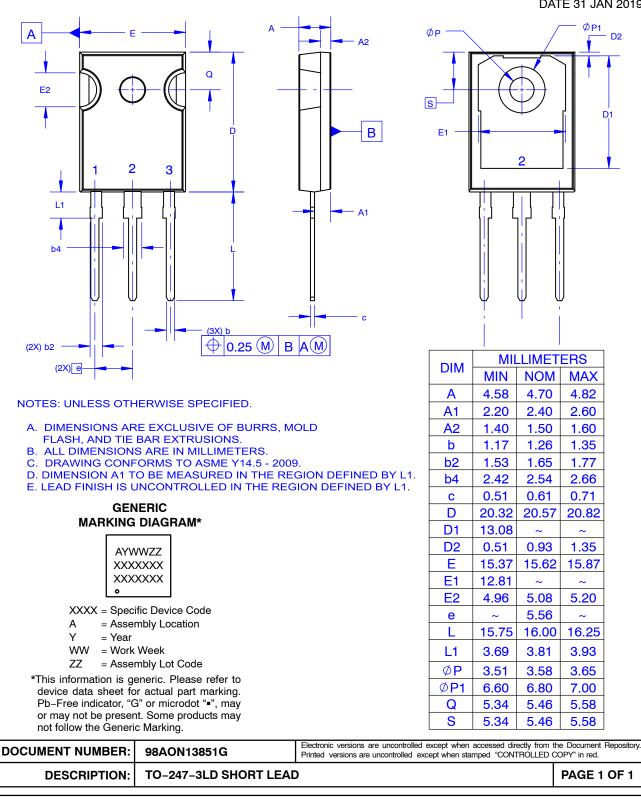


Figure 23. Transient Thermal Impedance of IGBT



TO-247-3LD SHORT LEAD CASE 340CK **ISSUE A**

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